

CRMCGL1006A

N-Channel 100V,6mΩ Typ. Power MOSFET

Description

Features

• 100V, 105A

 $R_{DS(ON)}$ Typ = 6m Ω @ V_{GS} = 10V

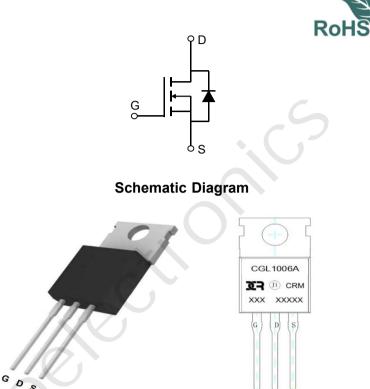
 $R_{DS(ON)}$ Typ = 7.7m Ω @ V_{GS} = 4.5V

Advanced Split Gate Trench Technology

- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

Application

- Load Switch
- PWM Application
- Power Management



Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	TUBE(pcs)	Inner Box (pcs)	Per Carton (pcs)
CRMCGL1006A	CRMCGL1006A	TO-220C-3L	TUBE	50	1000	5000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		100	V
V _{GS}	Gate-to-Source Voltage		±20	V
ID	Continuous Drain Current	T _C = 25°C	105	А
		T _C = 100°C	63	А
I _{DM}	Pulsed Drain Current ⁽¹⁾		420	А
E _{AS}	Single Pulsed Avalanche Energy ⁽²⁾		144	mJ
P _D	Power Dissipation	$T_c = 25^{\circ}C$	156	W
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case		0.8	°C/W
Τ _J , T _{stg}	Junction & Storage Temperature Range		-55 to 150	°C



Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	100	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 100V, V _{GS} = 0V	-	-	1.0	μΑ
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.4	1.85	2.4	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 10V, I _D = 30A	-	6	7.8	mΩ
		V _{GS} = 4.5V, I _D = 20A	-	7.7	10	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-	2200	-	pF
C _{oss}	Output Capacitance	V _{GS} = 0V, V _{DS} = 50V, f = 1MHz	Χ-	590	-	pF
C _{rss}	Reverse Transfer Capacitance			10	-	pF
Q _g	Total Gate Charge	0	<u> </u>	38	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 50V, I_D = 25A$	-	13	-	nC
Q_{gd}	Gate Drain("Miller") Charge	V _{DS} - 00V, I _D -20A	-	6	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	14	-	ns
t _r	Turn-On Rise Time	V _{GS} = 10V, V _{DD} = 50V	-	80	-	ns
$t_{d(off)}$	Turn-Off DelayTime	I_D = 25A, R_{GEN} = 3 Ω	-	46	-	ns
t _f	Turn-Off Fall Time		-	18	-	ns
Drain-So	urce Diode Characteristics and N	lax Ratings				
I _s	Maximum Continuous Drain to Source Diode Forward Current			-	105	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	420	А
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 30A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time		-	70	-	ns
Qrr	Body Diode Reverse Recovery Charge	I _F = 25A, di/dt = 100A/us	-	100	-	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2. E_{AS} condition: Starting T_J=25°C, V_{DD}=50V, V_G=10V, R_G=250hm, L=0.5mH, I_{AS}=24A

3. Pulse Test: Pulse Width ${\leqslant}300\mu s,$ Duty Cycle ${\leqslant}0.5\%.$



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Test Circuit

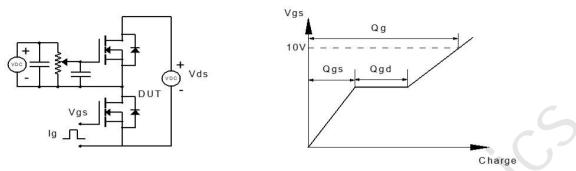


Figure 1: Gate Charge Test Circuit & Waveform

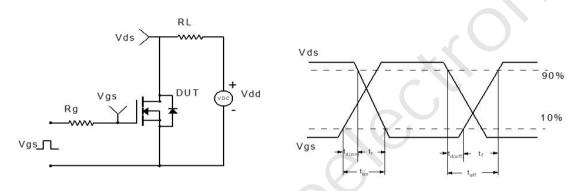
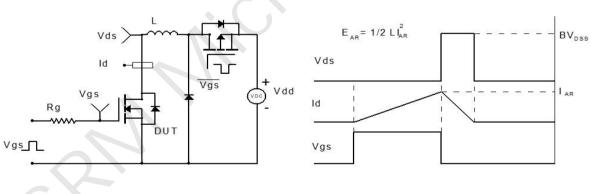


Figure 2: Resistive Switching Test Circuit & Waveform





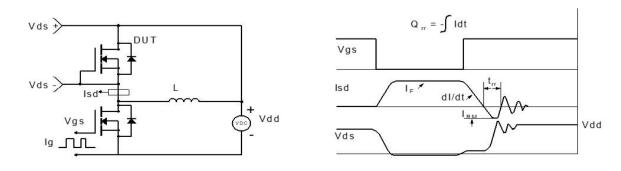


Figure 4: Diode Recovery Test Circuit & Waveform



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MAX

4.60

1.35

2, 50

0.90

1.45

0 60

16, 10

9.30

12,93

10,20

8.40

6.80

13.50

3, 10

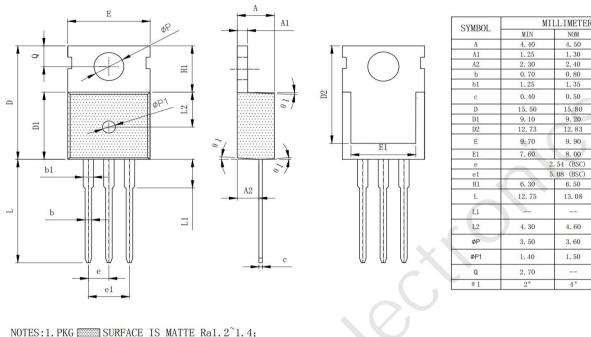
4,90

3.70

1.60

2,90

Package Mechanical Data(TO-220C-3L)



NOTES:1.PKG SURFACE IS MATTE Ra1.2^{~1.4}; OTHERS IS POLISHED Ra0.15;

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Contact information

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